

Reference Only

Spec.No.JENF243A-0034F--01

P1/7

GHz Noise Suppression Chip Ferrite Bead BLM03H Reference Specification

1.Scope

This specification applies to Chip Ferrite Bead BLM03H_SN Series.

2.Part Numbering

(ex.) BL M 03 HG 601 S N 1 D
 (1) (2) (3) (4) (5) (6) (7) (8) (9)

(1)Product ID (2)Type (3)Dimension(L×W) (4)Characteristics (5)Typical Impedance at 100MHz
 (6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

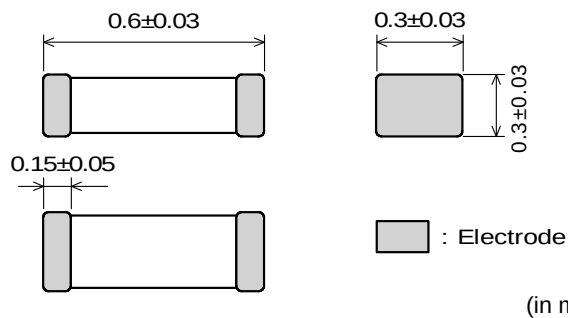
3.Rating

Customer Part Number	MURATA Part Number	Impedance (Ω) (Under Standard Testing Condition)		Rated Current (mA)	DC Resistance (Ω max.)		Remark
		at 100MHz	at 1GHz		Initial Values	Values After Testing	
	BLM03HG601SN1D BLM03HG601SN1B	600±25%	1000±40%	150	1.6	1.7	For general use
	BLM03HG102SN1D BLM03HG102SN1B	1000±25%	1800±40%	125	2.6	2.7	
	BLM03HG122SN1D BLM03HG122SN1B	1200±25%	2000±40%	100	3.5	3.6	
	BLM03HB191SN1D BLM03HB191SN1B	190±25%	1150±40%	150	2.0	2.1	
	BLM03HD331SN1D BLM03HD331SN1B	330±25%	750±40%	200	1.0	1.1	For High speed Signal line
	BLM03HD471SN1D BLM03HD471SN1B	470±25%	1000±40%	175	1.3	1.4	
	BLM03HD601SN1D BLM03HD601SN1B	600±25%	1500±40%	150	1.7	1.8	
	BLM03HD102SN1D BLM03HD102SN1B	1000±25%	2300±40%	120	2.9	3.0	

■ Operating Temperature : -55°C to +125°C

■ Storage Temperature : -55°C to +125°C

4.Style and Dimensions



■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

■ Unit Mass(Typical value)

0.0003g

5.Marking

No marking.

6.Standard Testing Conditions

< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C)

Humidity : Ordinary Humidity (25%(RH) to 85%(RH))

< In case of doubt >

Temperature : 20°C±2 °C

Humidity : 60%(RH) to 70%(RH)

Atmospheric pressure : 86kPa to 106kPa

7.Specifications

Reference Only

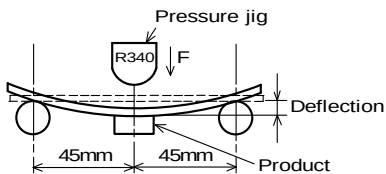
Spec.No.JENF243A-0034F--01

P2/7

7-1.Electrical Performance

No.	Item	Specification	Test Method
7-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz , 1GHz±1MHz Measuring Equipment : Agilent 4991A or the equivalent Test Fixture : Agilent 16197A or the equivalent
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter

7-2.Mechanical Performance

No.	Item	Specification	Test Method								
7-2-1	Appearance and Dimensions	Meet item 4.	Visual Inspection and measured with Measuring Microscope.								
7-2-2	Bending Strength	Meet Table 1. <table><tr><td colspan="2">Table 1</td></tr><tr><td>Appearance</td><td>No damage</td></tr><tr><td>Impedance Change (at 100MHz)</td><td>Within ±30%</td></tr><tr><td>DC Resistance</td><td>Meet item 3.</td></tr></table>	Table 1		Appearance	No damage	Impedance Change (at 100MHz)	Within ±30%	DC Resistance	Meet item 3.	It shall be soldered on the Glass-epoxy substrate. Substrate : 100mm×40mm×0.8mm Deflection : 1.0mm Speed of Applying Force : 0.5mm/s Keeping Time : 30s 
Table 1											
Appearance	No damage										
Impedance Change (at 100MHz)	Within ±30%										
DC Resistance	Meet item 3.										
7-2-3	Vibration		It shall be soldered on the substrate. Oscillation Frequency : 10Hz to 2000Hz to 10Hz for 20 min Total Amplitude 1.5mm or Acceleration 196m/s ² whichever is smaller Testing Time : A period of 2 hours in each of 3 mutually perpendicular directions. (Total 6 h)								
7-2-4	Resistance to Soldering Heat		Pre-Heating : 150°C±10°C, 60s~90s Solder : Sn-3.0Ag-0.5Cu Solder Temperature : 270°C±5°C Immersion Time : 10s±0.5s Immersion and emersion rates : 25mm/s Then measured after exposure in the room condition for 48h±4h.								
7-2-5	Solderability	The electrodes shall be at least 95% covered with new solder coating.	Flux : Ethanol solution of rosin,25(wt)% Pre-Heating : 150°C±10°C, 60s~90s Solder : Sn-3.0Ag-0.5Cu Solder Temperature : 240°C±5°C Immersion Time : 3s±1s Immersion and emersion rates : 25mm/s								

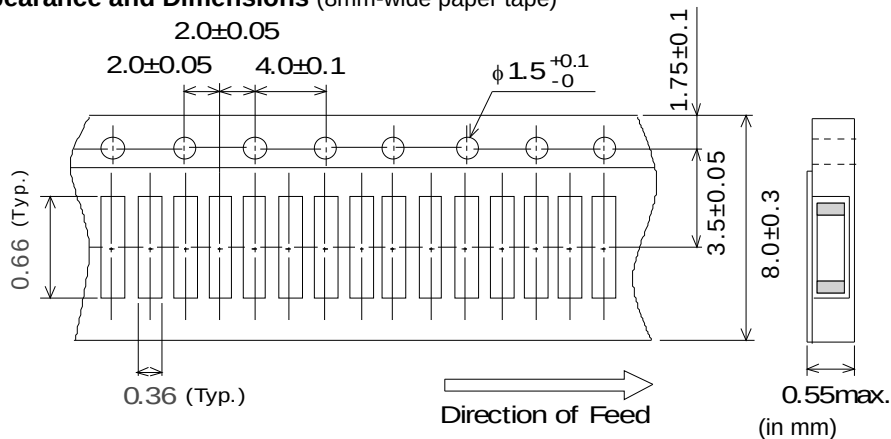
7-3.Environmental Performance

It shall be soldered on the substrate.

No.	Item	Specification	Test Method
7-3-1	Temperature Cycle	Meet Table 1.	1 cycle : 1 step : -55 °C(+0 °C,-3 °C) / 30min±3min 2 step : Ordinary temp. / 10min to 15min 3 step : +125 °C(+3 °C,-0 °C) / 30min±3min 4 step : Ordinary temp. / 10min to 15min Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity		Temperature : 70°C±2°C Humidity : 90%RH to 95%RH Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-3	Heat Life		Temperature : 125°C±3°C Applying Current : Rated Current Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance		Temperature : -55±2°C Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

8.Specification of Packaging

8-1.Appearance and Dimensions (8mm-wide paper tape)



(1)Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide, 2mm-pitch continuously and sealed by cover tape .

(2)Sprocket hole:Sprocket hole shall be located on the right hand side toward the direction of feed.

(3)Spliced point:The base tape and cover tape have no spliced point

(4)Cavity:There shall not be burr in the cavity.

(5)Missing components number

Missing components number within 0.1% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

8-2.Tape Strength

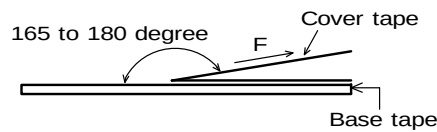
(1)Pull Strength

Cover tape	5N min.
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(2)Peeling off force of Cover tape

0.1N to 0.6N (Minimum value is typical.)

*Speed of Peeling off:300mm/min



8-3.Taping Condition

(1)Standard quantity per reel

Quantity per 180mm reel	15000 pcs. / reel
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(2)There shall be leader-tape(top tape and empty tape) and trailer- tape(empty tape) as follows.

(3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4) Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity, etc)

*1) « Expression of Inspection No. »

$\square\square$ (1) $\bigcirc\bigcirc\bigcirc\bigcirc$ (2) $\times\times\times$ (3)

(1) Factory Code

(2) Date

First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O,N,D

Third, Fourth digit : Day

(3) Serial No.

*2) « Expression of RoHS marking »

ROHS – Y ($\triangle$)
(1) (2)

(1) RoHS regulation conformity parts.

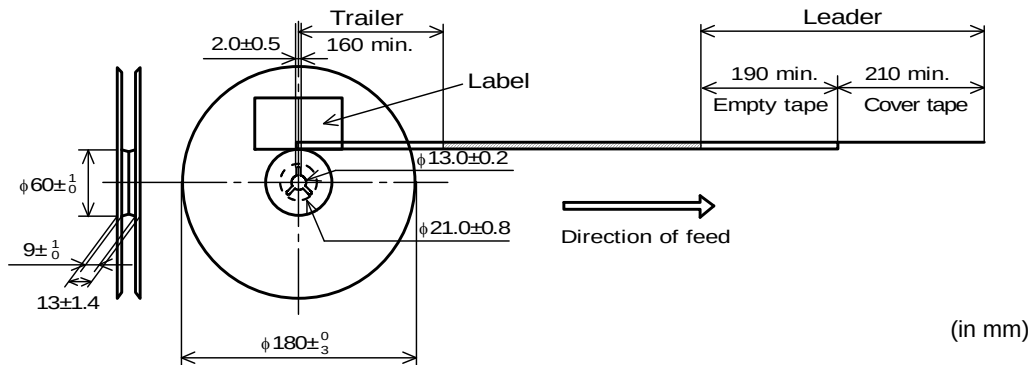
(2) MURATA classification number

(5) Outside package

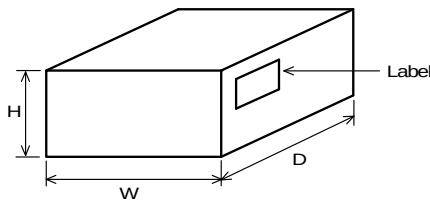
These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

(Customer name, Purchasing Order Number, Customer Part Number, MURATA part number, RoHS marking(*2) , Quantity , etc)

(6)Dimensions of reel and taping(leader-tape, trailer-tape)



8-4. Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case (Reel)
W	D	H	
186	186	93	5

* Above Outer Case size is typical. It depends on a quantity of an order.

9. ⚠ Caution

9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.
Please contact us in advance in case of applying the surge current.

9-2.Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- | | |
|----------------------------------|--|
| (1)Aircraft equipment | (6)Disaster prevention / crime prevention equipment |
| (2)Aerospace equipment | (7)Traffic signal equipment |
| (3)Undersea equipment | (8)Transportation equipment (vehicles,trains,ships,etc.) |
| (4)Power plant control equipment | (9)Applications of similar complexity and /or reliability requirements to the applications listed in the above |
| (5)Medical equipment | |

10. Notice

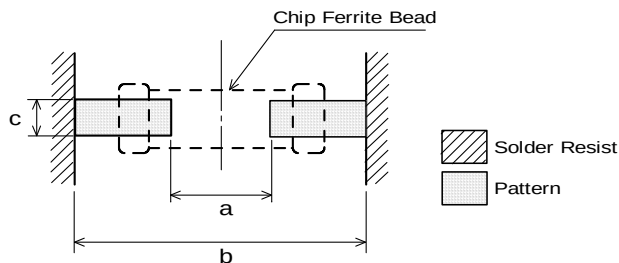
Products can only be soldered with reflow.

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

10-1.Land pattern designing

- Standard land dimensions (Reflow soldering)



a	b	c
0.2 to 0.3	0.6 to 0.9	0.3

(in mm)

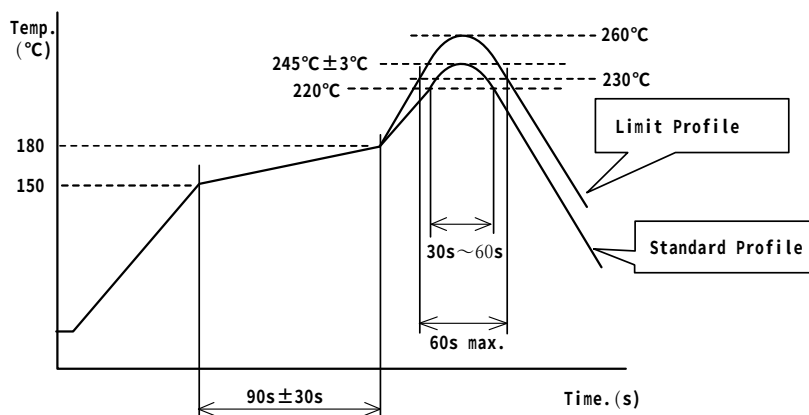
10-2.Soldering Conditions

(1) Flux,Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.) Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder Standard thickness of solder paste : 100 μm to 150 μm

(2) Soldering conditions

- Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.
Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.
- Standard soldering profile and the limit soldering profile is as follows.
The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.



	Standard Profile	Limit Profile
Pre-heating	150~180°C、90s±30s	
Heating	above 220°C、30s~60s	above 230°C、60s max.
Peak temperature	245±3°C	260°C,10s
Cycle of reflow	2 times	2 times

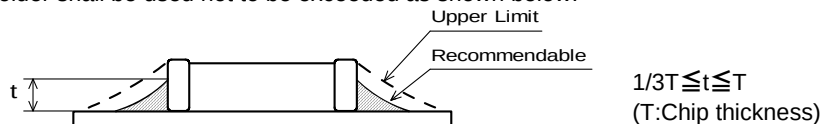
10-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
- Tip temperature: 350°C max.
- Soldering time : 3(+1,-0) seconds.
- Soldering iron output: 80W max.
- Tip diameter: φ 3mm max.
- Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

10-4.Solder Volume

Solder shall be used not to be exceeded as shown below.



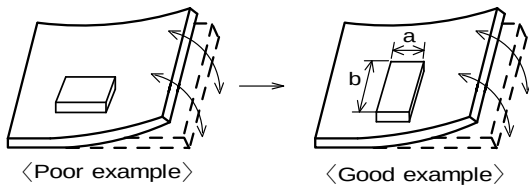
Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

10-5.Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

- (1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage.

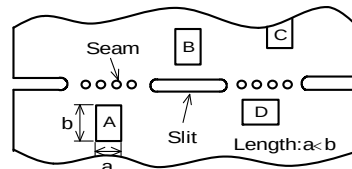
<Products direction>



Products shall be located in the sideways direction (Length: $a < b$) to the mechanical stress.

- (2) Products location on P.C.B. separation.

Products (A,B,C,D) shall be located carefully so that products are not subject to the mechanical stress due to warping the board. Because they may be subjected the mechanical stress in order of $A > C > B \cong D$.



10-6.Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

10-7.Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max. (40°C max. for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.
Power: 20W/l max. Frequency: 28kHz to 40kHz Time: 5 min max.
- (3) Cleaner
 1. Alternative cleaner
 - Isopropyl alcohol (IPA)
 2. Aqueous agent
 - PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.
In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning
Please contact us.

10-8. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere (acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc.)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

10-9. Resin coating

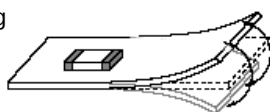
The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

10-10. Handling of a substrate

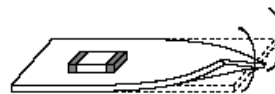
After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.

Bending



Twisting



10-11.Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

- Products should be stored in the warehouse on the following conditions.

Temperature : -10°C to 40°C

Humidity : 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be stored under the airtight packaged condition.

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11. Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.